

# ANTREX Electronics

Electronic Components Sourcing Information

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## Product Reference Information

**Part Number:** GA400TD25S  
**Manufacturer:** Vishay General Semiconductor - Diodes Division  
**Package:** Dual INT-A-PAK (3 + 8)  
**Availability:** Please confirm with sales

**Product Page:**

<https://antrexco.com/product/details/vishay-general-semiconductor-diodes-division/ga400td25s.html>

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## Contact Information

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## Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

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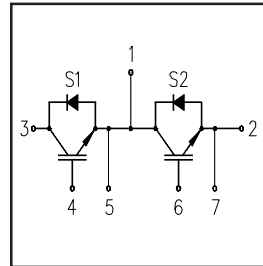
# GA400TD25S

"HALF-BRIDGE" IGBT DUAL INT-A-PAK

Standard Speed IGBT

## Features

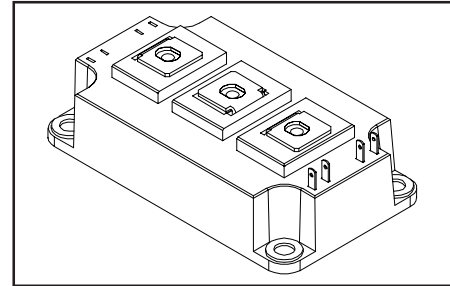
- Generation 4 IGBT technology
- Standard: Optimized for minimum saturation voltage and operating frequencies up to 10kHz
- Very low conduction and switching losses
- HEXFRED™ antiparallel diodes with ultra- soft recovery
- Industry standard package
- UL approved



$V_{CES} = 250V$   
 $V_{CE(on)} \text{ typ.} = 1.3V$   
 @  $V_{GE} = 15V, I_C = 400A$

## Benefits

- Increased operating efficiency
- Direct mounting to heatsink
- Performance optimized for power conversion: UPS, SMPS, Welding
- Lower EMI, requires less snubbing



## Absolute Maximum Ratings

|                          | Parameter                                                        | Max.        | Units      |
|--------------------------|------------------------------------------------------------------|-------------|------------|
| $V_{CES}$                | Collector-to-Emitter Voltage                                     | 250         | V          |
| $I_C @ T_C = 25^\circ C$ | Continuous Collector Current                                     | 400         | A          |
| $I_{CM}$                 | Pulsed Collector Current①                                        | 800         |            |
| $I_{LM}$                 | Peak Switching Current②                                          | 800         |            |
| $I_{FM}$                 | Peak Diode Forward Current                                       | 800         |            |
| $V_{GE}$                 | Gate-to-Emitter Voltage                                          | $\pm 20$    | V          |
| $V_{ISOL}$               | RMS Isolation Voltage, Any Terminal To Case, $t = 1 \text{ min}$ | 2500        | W          |
| $P_D @ T_C = 25^\circ C$ | Maximum Power Dissipation                                        | 1350        |            |
| $P_D @ T_C = 85^\circ C$ | Maximum Power Dissipation                                        | 700         | $^\circ C$ |
| $T_J$                    | Operating Junction Temperature Range                             | -40 to +150 |            |
| $T_{STG}$                | Storage Temperature Range                                        | -40 to +125 |            |

## Thermal / Mechanical Characteristics

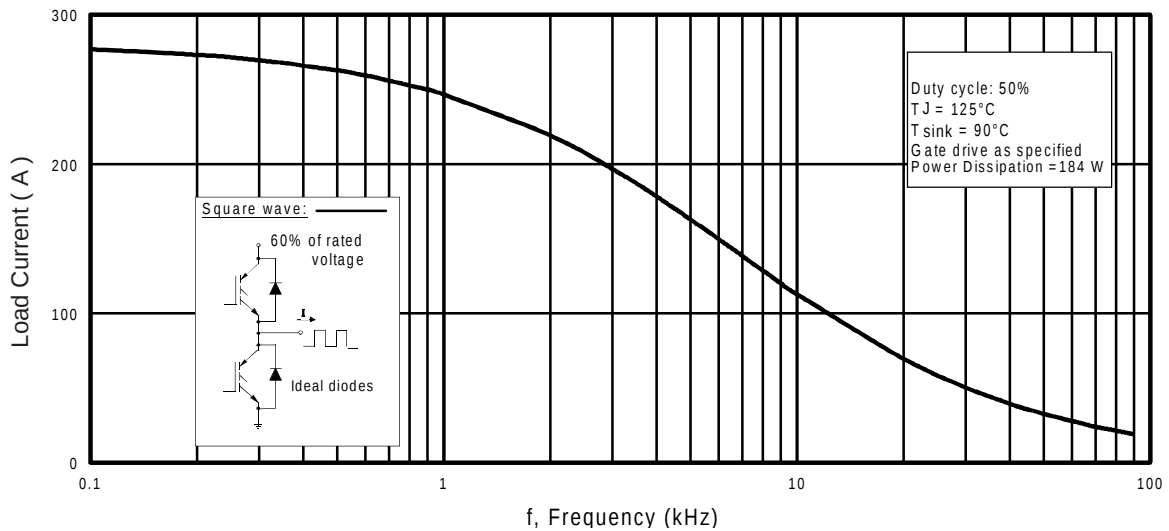
|                 | Parameter                                    | Typ. | Max. | Units        |
|-----------------|----------------------------------------------|------|------|--------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case - IGBT  | —    | 0.09 | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case - Diode | —    | 0.20 |              |
| $R_{\theta CS}$ | Thermal Resistance, Case-to-Sink - Module    | 0.1  | —    |              |
|                 | Mounting Torque, Case-to-Heatsink ③          | —    | 6.0  | N·m          |
|                 | Mounting Torque, Case-to-Terminal 1, 2 & 3③  | —    | 5.0  |              |
|                 | Weight of Module                             | 400  | —    | g            |

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

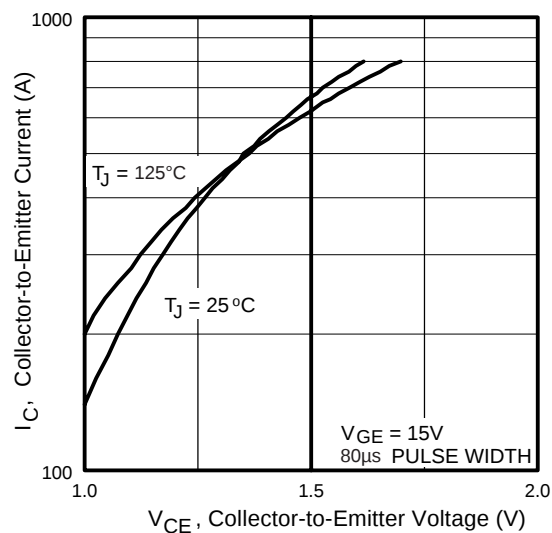
|                                | Parameter                               | Min. | Typ. | Max. | Units                | Conditions                                            |
|--------------------------------|-----------------------------------------|------|------|------|----------------------|-------------------------------------------------------|
| $V_{(BR)CES}$                  | Collector-to-Emitter Breakdown Voltage  | 250  | —    | —    | V                    | $V_{GE} = 0V, I_C = 1mA$                              |
| $V_{CE(on)}$                   | Collector-to-Emitter Voltage            | —    | 1.3  | 1.6  |                      | $V_{GE} = 15V, I_C = 400A$                            |
|                                |                                         | —    | 1.3  | —    |                      | $V_{GE} = 15V, I_C = 400A, T_J = 125^\circ\text{C}$   |
| $V_{GE(th)}$                   | Gate Threshold Voltage                  | 3.0  | —    | 6.0  |                      | $I_C = 3.0mA$                                         |
| $\Delta V_{GE(th)}/\Delta T_J$ | Temperature Coeff. of Threshold Voltage | —    | -11  | —    | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 2.5mA$                        |
| $g_{fe}$                       | Forward Transconductance④               | —    | 371  | —    | S                    | $V_{CE} = 25V, I_C = 400A$                            |
| $I_{CES}$                      | Collector-to-Emitter Leaking Current    | —    | —    | 0.50 | mA                   | $V_{GE} = 0V, V_{CE} = 250V$                          |
|                                |                                         | —    | —    | 20   |                      | $V_{GE} = 0V, V_{CE} = 250V, T_J = 125^\circ\text{C}$ |
| $V_{FM}$                       | Diode Forward Voltage - Maximum         | —    | 1.7  | 2.2  | V                    | $I_F = 500A, V_{GE} = 0V$                             |
|                                |                                         | —    | 1.7  | —    |                      | $I_F = 500A, V_{GE} = 0V, T_J = 125^\circ\text{C}$    |
| $I_{GES}$                      | Gate-to-Emitter Leakage Current         | —    | —    | 500  | nA                   | $V_{GE} = \pm 20V$                                    |

**Dynamic Characteristics -  $T_J = 125^\circ\text{C}$  (unless otherwise specified)**

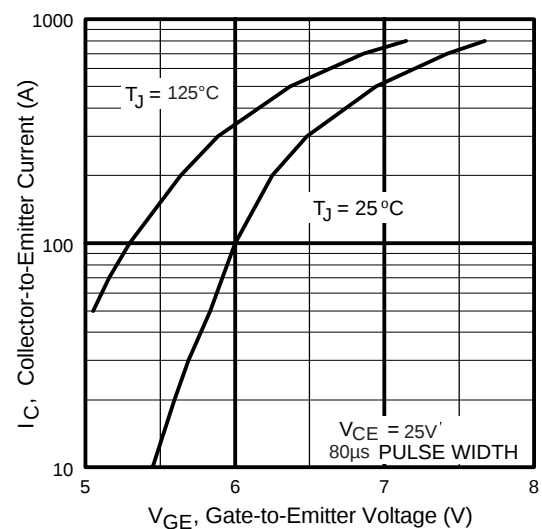
|                  | Parameter                                        | Min. | Typ.  | Max. | Units            | Conditions                                     |
|------------------|--------------------------------------------------|------|-------|------|------------------|------------------------------------------------|
| $Q_g$            | Total Gate Charge (turn-on)                      | —    | 1600  | 2400 | nC               | $V_{CC} = 200V$                                |
| $Q_{ge}$         | Gate - Emitter Charge (turn-on)                  | —    | 232   | 348  |                  | $I_C = 440A$                                   |
| $Q_{gc}$         | Gate - Collector Charge (turn-on)                | —    | 528   | 792  |                  | $T_J = 25^\circ\text{C}$                       |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 1250  | —    | ns               | $R_{G1} = 15\Omega, R_{G2} = 0\Omega,$         |
| $t_r$            | Rise Time                                        | —    | 365   | —    |                  | $I_C = 400A$                                   |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 841   | —    |                  | $V_{CC} = 150V$                                |
| $t_f$            | Fall Time                                        | —    | 792   | —    |                  | $V_{GE} = \pm 15V$                             |
| $E_{on}$         | Turn-On Switching Energy                         | —    | 6.0   | —    | mJ               | See Fig.17 through Fig.21                      |
| $E_{off}$        | Turn-Off Switching Energy                        | —    | 38    | —    |                  |                                                |
| $E_{ts}$         | Total Switching Energy                           | —    | 45    | 52   |                  |                                                |
| $C_{ies}$        | Input Capacitance                                | —    | 36000 | —    | pF               | $V_{GE} = 0V$                                  |
| $C_{oes}$        | Output Capacitance                               | —    | 4080  | —    |                  | $V_{CC} = 30V$                                 |
| $C_{res}$        | Reverse Transfer Capacitance                     | —    | 800   | —    |                  | $f = 1\text{ MHz}$                             |
| $t_{rr}$         | Diode Reverse Recovery Time                      | —    | 229   | —    | ns               | $I_C = 400A$                                   |
| $I_{rr}$         | Diode Peak Reverse Current                       | —    | 71    | —    | A                | $R_{G1} = 15\Omega$                            |
| $Q_{rr}$         | Diode Recovery Charge                            | —    | 8154  | —    | nC               | $R_{G2} = 0\Omega$                             |
| $di_{(rec)M}/dt$ | Diode Peak Rate of Fall of Recovery During $t_b$ | —    | 911   | —    | A/ $\mu\text{s}$ | $V_{CC} = 150V$<br>$di/dt > 1400A/\mu\text{s}$ |



**Fig. 1** - Typical Load Current vs. Frequency  
(Load Current =  $I_{RMS}$  of fundamental)



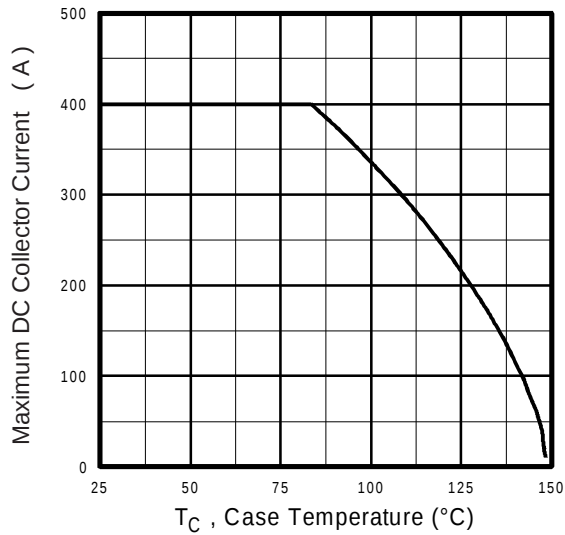
**Fig. 2** - Typical Output Characteristics



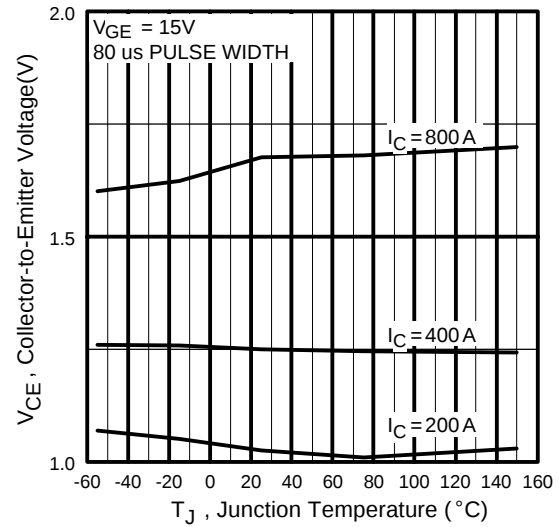
**Fig. 3** - Typical Transfer Characteristics

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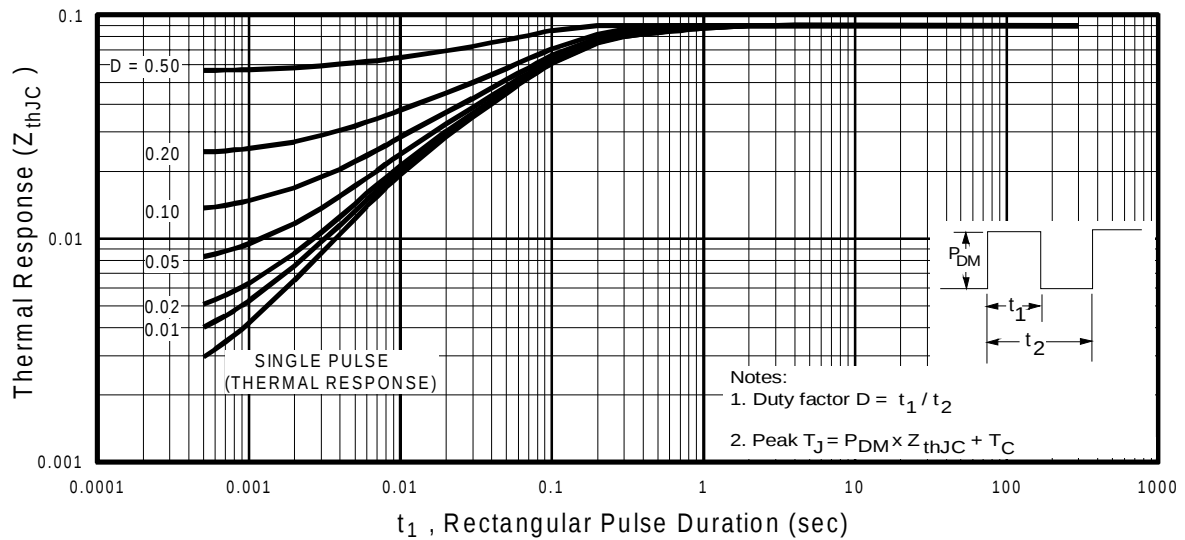
International  
**IRF** Rectifier



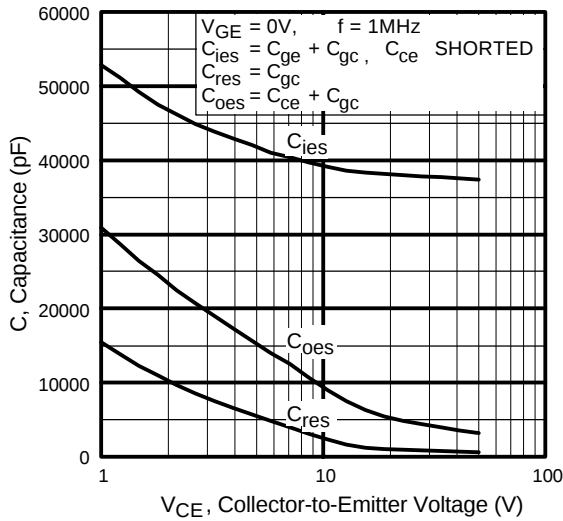
**Fig. 4** - Maximum Collector Current vs. Case Temperature



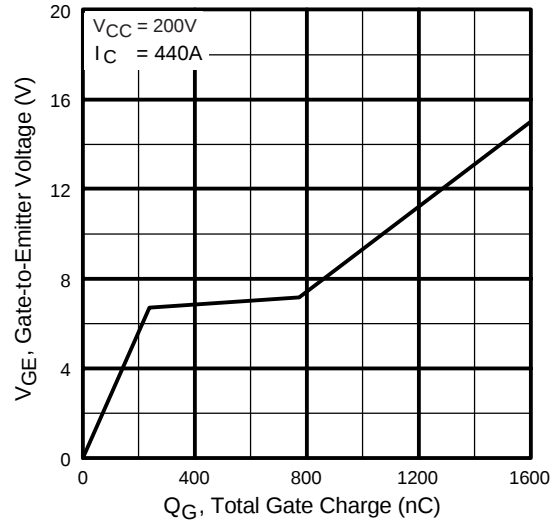
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



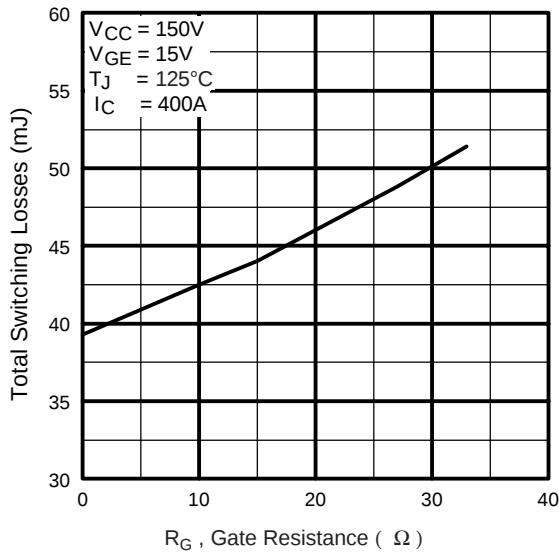
**Fig. 6** - Maximum Effective Transient Thermal Impedance, Junction-to-Case



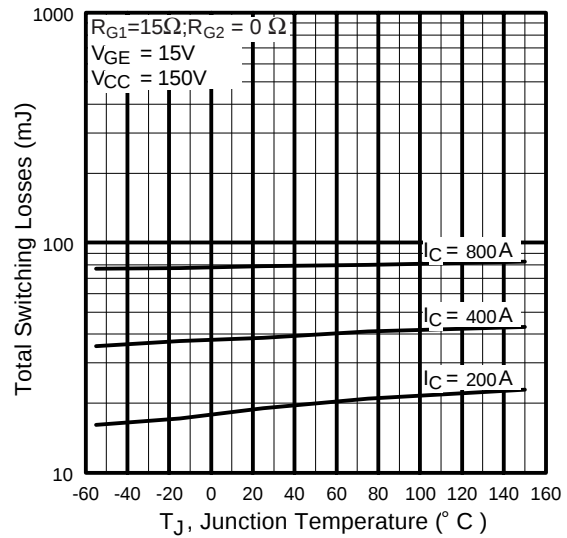
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage



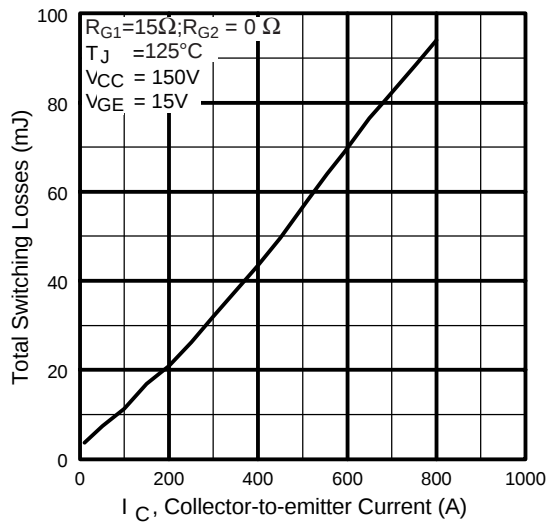
**Fig. 9** - Typical Switching Losses vs. Gate Resistance



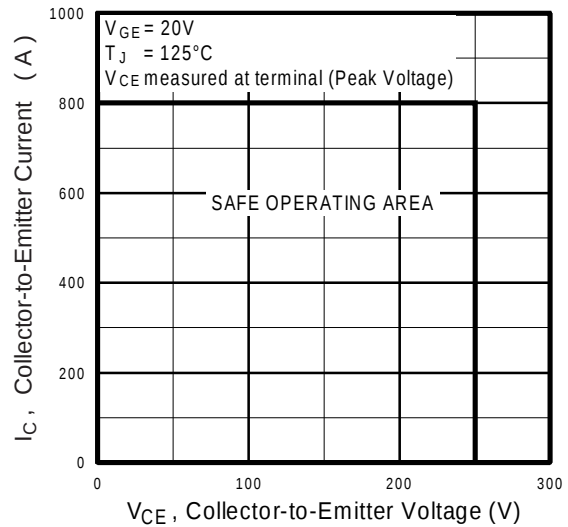
**Fig. 10** - Typical Switching Losses vs. Junction Temperature

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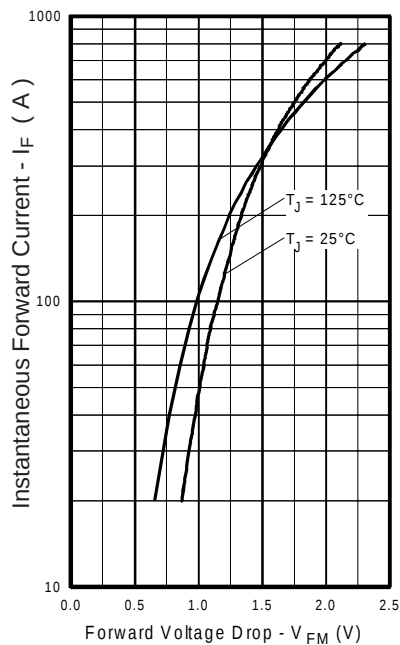
International  
**IR** Rectifier



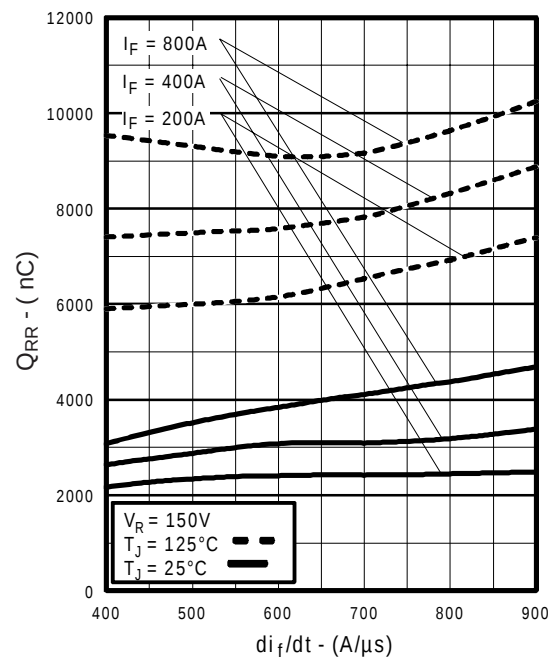
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



**Fig. 12** - Reverse Bias SOA



**Fig. 13** - Typical Forward Voltage Drop vs. Instantaneous Forward Current



**Fig. 14** - Typical Stored Charge vs.  $di_f/dt$

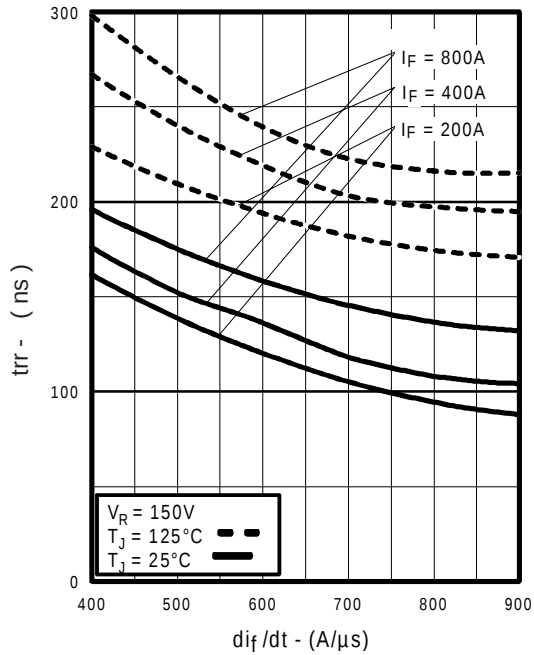


Fig. 15 - Typical Reverse Recovery vs.  $di_T/dt$

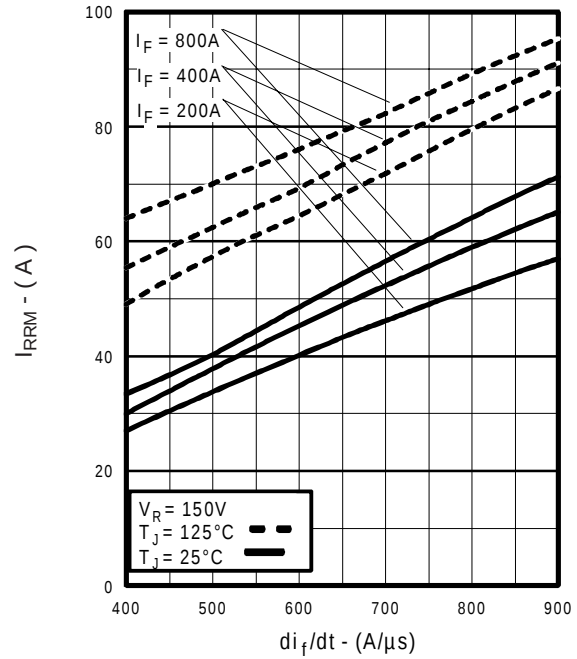
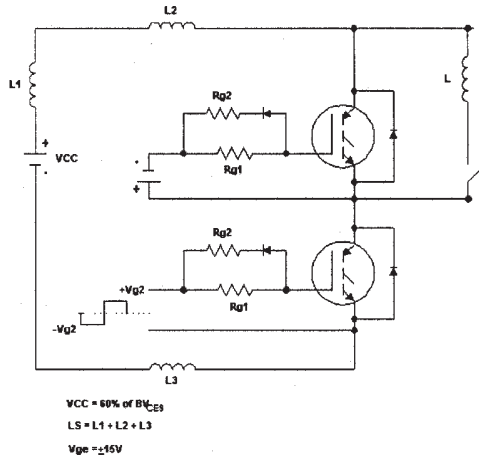


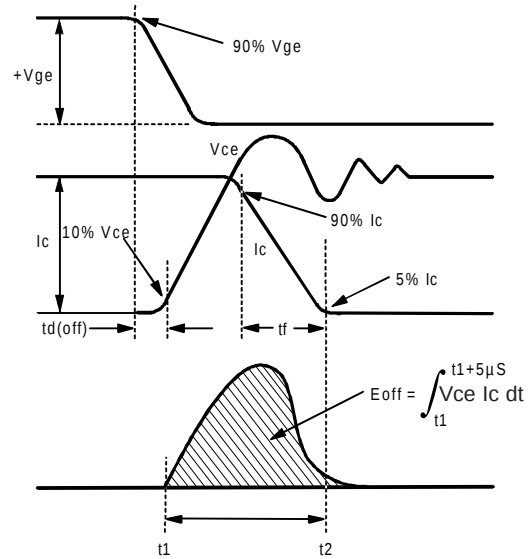
Fig. 16 - Typical Recovery Current vs.  $di_T/dt$

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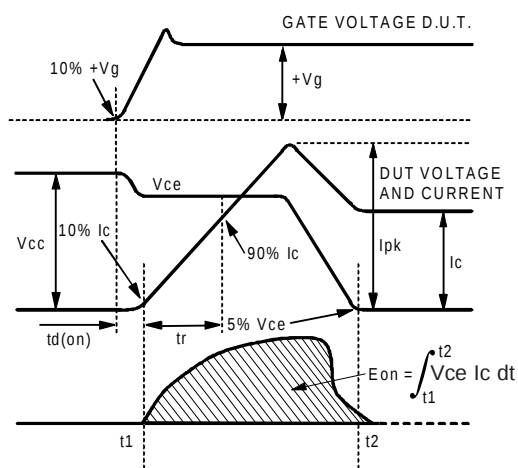
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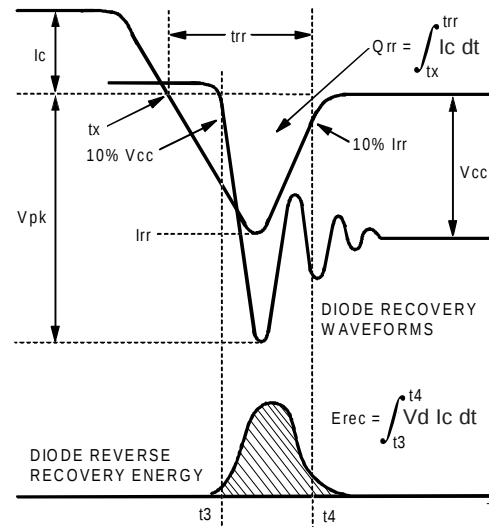
**Fig. 17** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off}(\text{diode})$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18** - Test Waveforms for Circuit of Fig. 17, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 19** - Test Waveforms for Circuit of Fig. 17, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 20** - Test Waveforms for Circuit of Fig. 17, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

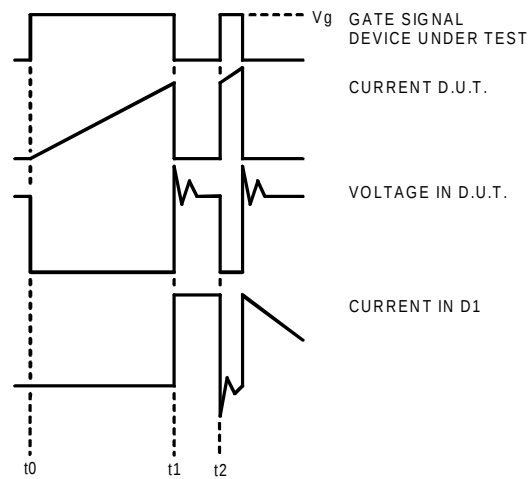


Figure 21. Macro Waveforms for Figure 17's Test Circuit

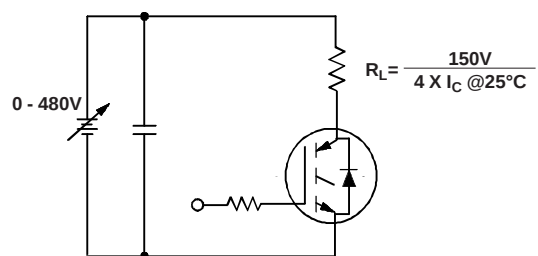


Figure 22. Pulsed Collector Current  
Test Circuit

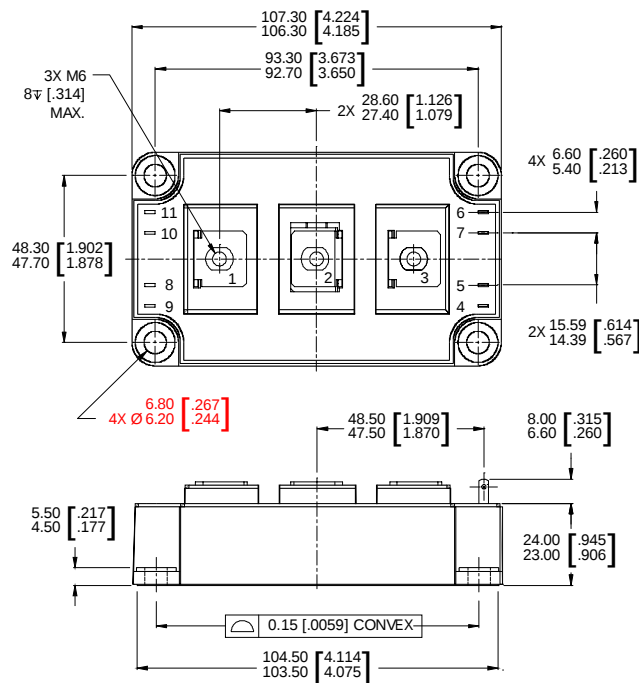
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## Notes:

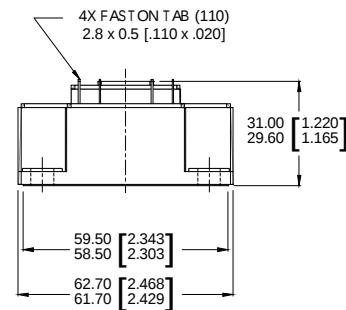
- ① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature.
- ② See fig. 17
- ③ For screws M6.
- ④ Pulse width 80μs; single shot.

## Case Outline — DUAL INT-A-PAK



## NOTES:

1. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
2. CONTROLLING DIMENSION: MILLIMETER.



Data and specifications subject to change without notice.  
This product has been designed and qualified for the Industrial market.  
Qualification Standards can be found on IR's Web site.

International  
**IR** Rectifier

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